

Electronic Acknowledgement Receipt

EFS ID:	1998052
Application Number:	10596387
International Application Number:	
Confirmation Number:	5987
Title of Invention:	EPOXY RESIN MOLDING MATERIAL FOR SEALING AND ELECTRONIC COMPONENT
First Named Inventor/Applicant Name:	Kazuyoshi Tendou
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Attorney Docket Number:	MIYOSH0006
Receipt Date:	23-JUL-2007
Filing Date:	
Time Stamp:	11:21:23
Application Type:	U.S. National Stage under 35 USC 371

Payment information:

Submitted with Payment	no
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement (IDS) Filed	07-07-23_IDS_before_with_cert.pdf	76341 f3e0d1d1ab24546d66fb428496a91c8a401d66b0	no	3

Warnings:

Information:					
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2	Information Disclosure Statement (IDS) Filed	07-07-23_US_IDS_Form__S B_08a.pdf	1053178 <small>fdf325018653774ea4b4eb11570d12316 196932d</small>	no	4
Warnings:					
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3	Foreign Reference	FR01_KR2001-0074819.pdf	1223212 <small>5a1b3078e8364f739c70f869c4502d05 2b248736</small>	no	22
Warnings:					
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4	NPL Documents	NPL01_Korean_Office_Actio n.pdf	619323 <small>23869ddb166092800872fa1fff078108d 6019e73</small>	no	13
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